(949) 660-0761



As the below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name and that I believe I am an original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

MOSFET STRUCTURE WITH REDUCED JUNCTION CAPACITANCE

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	Number	Country	Date Filed(yyyy/mm/dd)	Yes No		
	90126667 T	aiwan, R.O.C.	2001/10/29	Х		
I hereby appoint the following attorney(s transact all business in the Patent and Tradem Jiawei Huang (Reg. No. 43,336 Maria Erlinda C. Sarno (Reg. No. 37,436 Belinda Lee (Reg. No. 46,863		nark Office connected therewing the connected the connected therewing the connected the connected therewing the connected the conn	• •	id to		
	SEND CORRESPONDE	NCE TO:	DIRECT TELEPHONE CALLS TO: (Name and telephone number)			
	J.C. Patents, Inc. 4 Venture, Suite 250 Irvine, CA 92618		Jiawei Huang (949) 660-0762			

COMBINED DECLARATION AND POWER OF ATTORNEY CONTINUED

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patents issued thereon.

Signature: Yoo Wan Chang	Date: November 22, 2001				
Sole or First Joint Inventor: Yao Wen @hang					
Citizenship: Taiwan, R.O.C.					
Residence and Post Office Address: 5F-3,No.21, Lane 23, Guan-Dung Rd., Hsinchu, Taiwan, R.O.C.					
Signature: Tav Cheng Lu	Date: November 22, 2001				
Second Joint Inventor (if any): Tao-Cheng Lu					
Citizenship: Taiwan, R.O.C.					
Residence and Post Office Address: No. 36, Lane 1, Nen-Jiang St., Kaoshiung, Taiwan, R.O.C.					